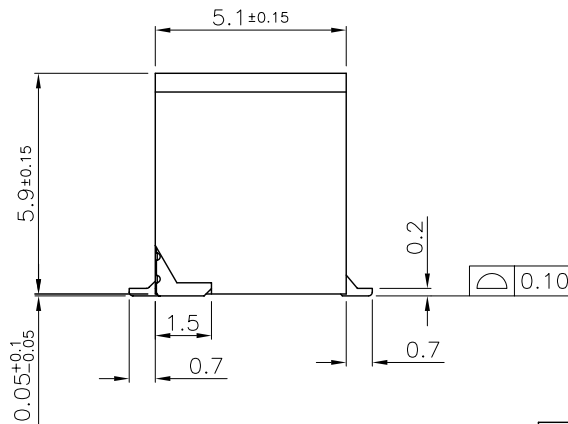
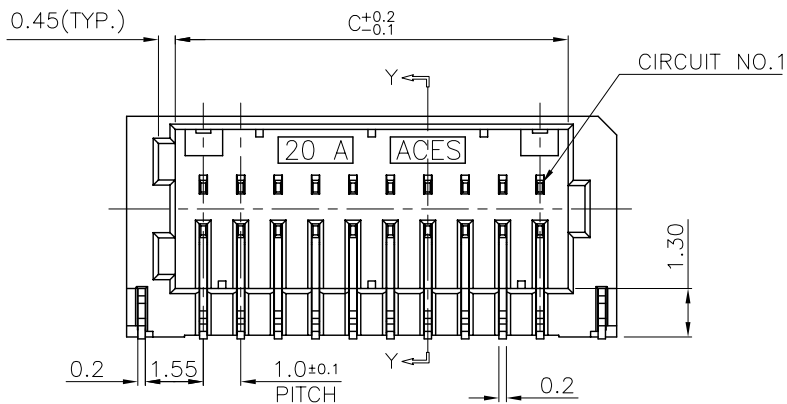


RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ± 0.05



NOTES:

1. MATERIAL:

1.1 HOUSING: HALOGEN FREE PLASTIC, HIGH TEMP.,
UL94V-0.

1.2 CONTACT: COPPER ALLOY

1.3 FITTING NAIL: COPPER ALLOY

2. FINISH:

2.1 CONTACT: 50u"~100u" NICKEL UNDERPLATING OVERALL.

1:1u"~3u" GOLD FLASH PLATING OVERALL.

N:100u"~200u" MATT TIN(LEAD FREE) OVERALL,

L:100u"~200u" PURE TIN(LEAD FREE) OVERALL,

2.2 FITTING NAIL:50u"~100u" NICKEL UNDERPLATING OVERALL

1:1u"~3u" GOLD FLASH PLATING OVERALL.

N:100u"~200u" MATT TIN(LEAD FREE) OVERALL.

L:100u"~200u" PURE TIN(LEAD FREE) OVERALL,

3. REFLOW SOLDER CAPABLE TO 260°C PER ACES SPEC.

4. SPEC. PLS. REFER TO PS-50246-XXXX-XXX

5. PACKAGE PLS. REFER TO 88407-XXXX-TRP

6. PART NUMBER

P/N LEGEND

50223-XXX X X-XXX

NO OF CKT

PACKING

0:TAPE & REEL

1:TUBE

PLATING

L:PURE TIN(LEAD FREE)

1: G/F OVERALL(LEAD FREE)

N: MATT TIN(LEAD FREE)

XXX	Housing Color
001	Black

CKT	Dim A	Dim B	Dim C	狀態欄
8	3.0	7.1	4.4	
10	4.0	8.1	5.4	
12	5.0	9.1	6.4	
16	7.0	11.1	8.4	
18	8.0	12.1	9.4	
20	9.0	13.1	10.4	
24	11.0	15.1	12.4	
30	14.0	18.1	15.4	v
34	16.0	20.1	17.4	
40	19.0	23.1	20.4	v
50	24.0	28.1	25.4	
60	29.0	33.1	30.4	

一般公差
TOLERANCES
X ± 0.5 XX ± 0.15
X ± 0.25 XXX ± 0.1
ANGLES $\pm 2^\circ$

檢驗尺寸標示

SYMBOLS INDICATE
CLASSIFICATION DIMENSION

MARK IS CRITICAL DIM.

MARK IS MAJOR DIM.

表面處理 (FINISH)

宏致電子股份有限公司
Aces Electronic Co.,Ltd.

品名 (TITLE)
1.0mm WTB WAFER
SMT R/A D/R TYPE

圖號 (DWG.NO)
50223-XXXXX-XXX

比例 (SCALE) 單位 (UNITS)

5:1 mm

製圖 (DR)
'08/10/13 liuwei

審核 (CHKD)
Sam

核准 (APPD)
Jason

張數 (SHEET)
1 OF 1

SIZE
A4

REV
A

A	修改參考SPEC	'08/12/29	liuwei
O	NEWDRAWING	'08/10/13	liuwei
修改 REV	修改摘要 REVISION DESCRIPTION	日期 DATE	簽名 SIGNATURE